

MOSFET

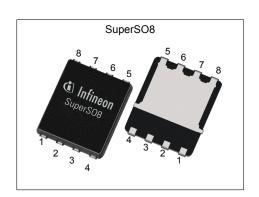
OptiMOS™3 Power-Transistor, 40 V

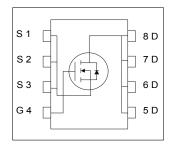
Features

- Fast switching MOSFET for SMPS
 Optimized technology for DC/DC converters
 Qualified according to JEDEC¹⁾ for target applications
 N-channel; Logic level
- Excellent gate charge x RDS(on) product (FOM)
 Very low on-resistance RDS(on)
- Superior thermal resistance
- 100% Avalanche tested
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21



Table 1 1to j 1 circumantes 1 anameters						
Parameter	Value	Unit				
V _{DS}	40	V				
$R_{\mathrm{DS(on),max}}$	1.8	mΩ				
I_{D}	209	A				











Type / Ordering Code	Package	Marking	Related Links
BSC018N04LS G	PG-TDSON-8	018N04LS	-



Table of Contents

scription
aximum ratings
ermal characteristics
ectrical characteristics
ectrical characteristics diagrams 6
ckage Outlines
vision History
ademarks
sclaimer



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	O. mak al	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I_{D}	- - - -	- - - -	209 132 180 114 30	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	836	Α	<i>T</i> _C =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	50	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse	E _{AS}	-	-	295	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	125 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 K/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1	K/W	-	
Thermal resistance, junction - case, top	R _{thJC}	-	-	18	K/W	-	
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	-	-	50	K/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See figure 3 for more detailed information

4) See figure 13 for more detailed information



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Courado a l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	40	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	-	2	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=85\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =40 V, V _{GS} =0 V, T _j =25 °C V _{DS} =40 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.0 1.5	2.5 1.8	mΩ	V _{GS} =4.5 V, I _D =50 A V _{GS} =10 V, I _D =50 A
Gate resistance	R _G	-	1.3	-	Ω	-
Transconductance	g fs	90	180	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 **Dynamic characteristics**

Developer	Cumbal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	C _{iss}	-	8900	12000	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	1800	2400	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Reverse transfer capacitance	C _{rss}	-	100	-	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Turn-on delay time	t _{d(on)}	-	13	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Rise time	t _r	-	7.4	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	55	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Fall time	t _f	-	9.0	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Davamatav	Cumb al	Values			11:4	Note / Took Condition
Parameter	Symbol		Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	26	-	nC	V _{DD} =20 V, I _D =30 A, V _{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	14	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	Q _{gd}	-	11	-	nC	V _{DD} =20 V, I _D =30 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	23	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	113	150	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	2.9	-	V	V _{DD} =20 V, I _D =30 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	54	72	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total, sync. FET	Q _{g(sync)}	-	106	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	69	-	nC	V _{DD} =20 V, V _{GS} =0 V

 $^{^{\}rm 1)}$ Defined by design. Not subject to production test $^{\rm 2)}$ See "Gate charge waveforms" for parameter definition

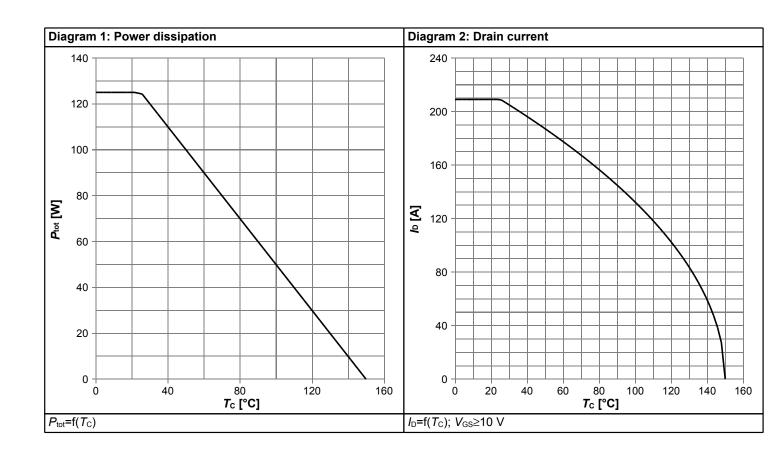


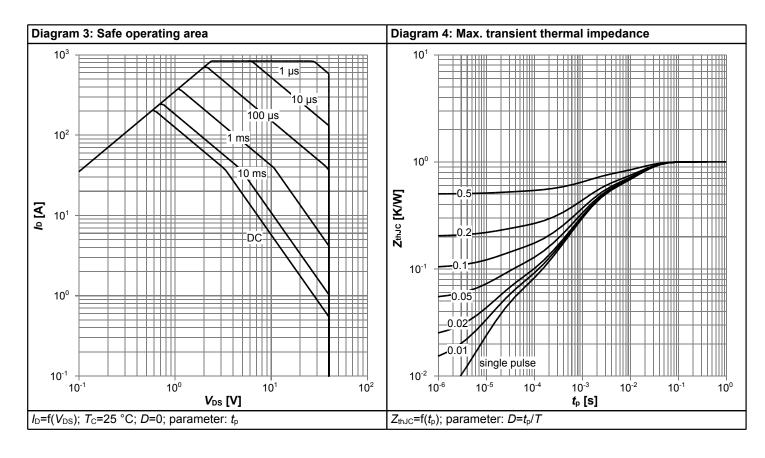
Table 7 Reverse diode

Doromotor	Sumbol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	104	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	836	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.81	1.2	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C	
Reverse recovery charge	Qrr	-	125	-	nC	V _R =20 V, I _F =I _S , di _F /dt=400 A/µs	

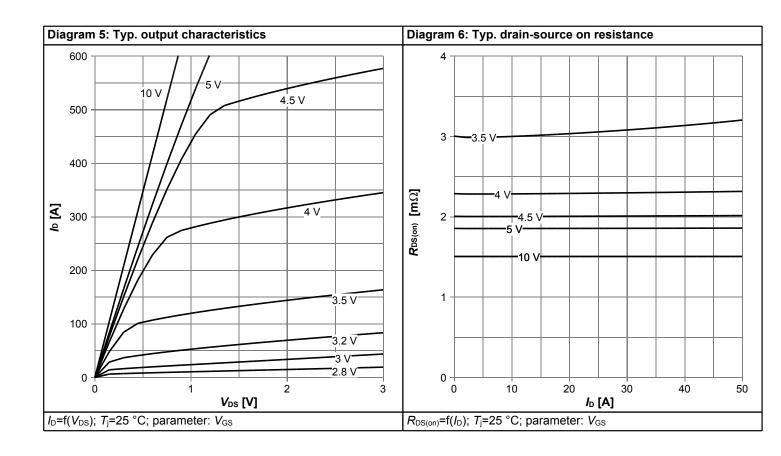


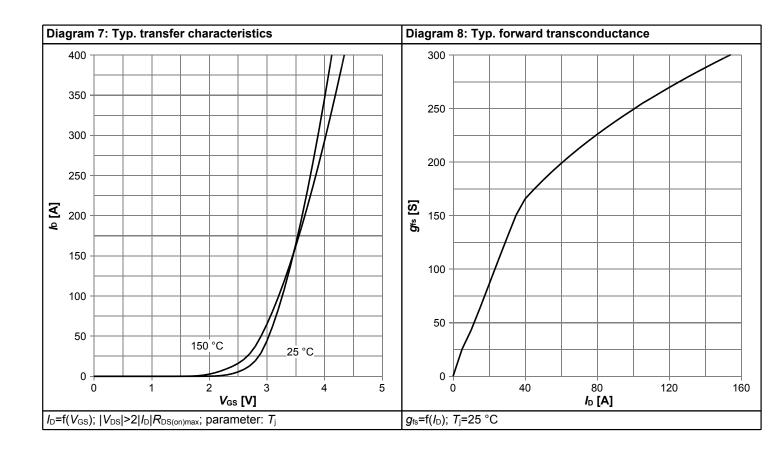
4 Electrical characteristics diagrams



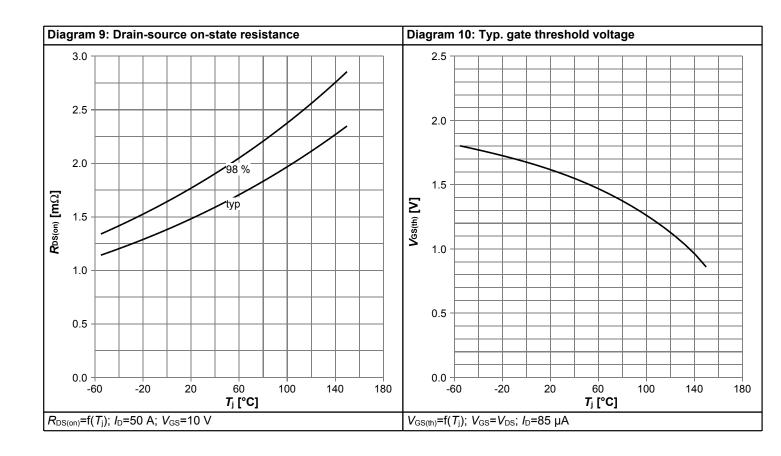


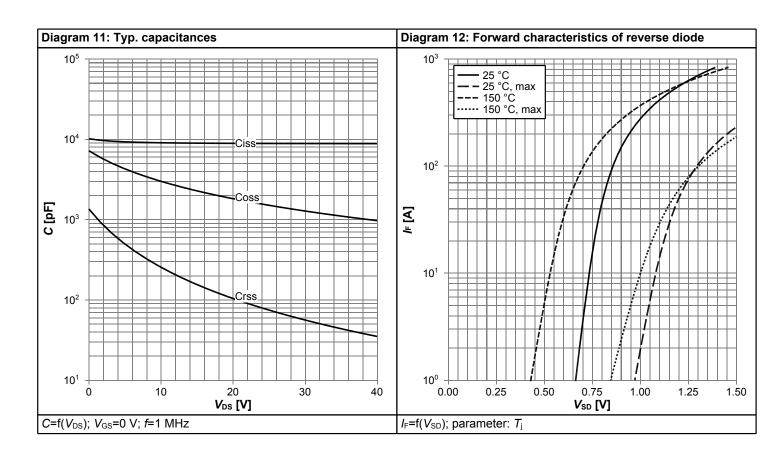




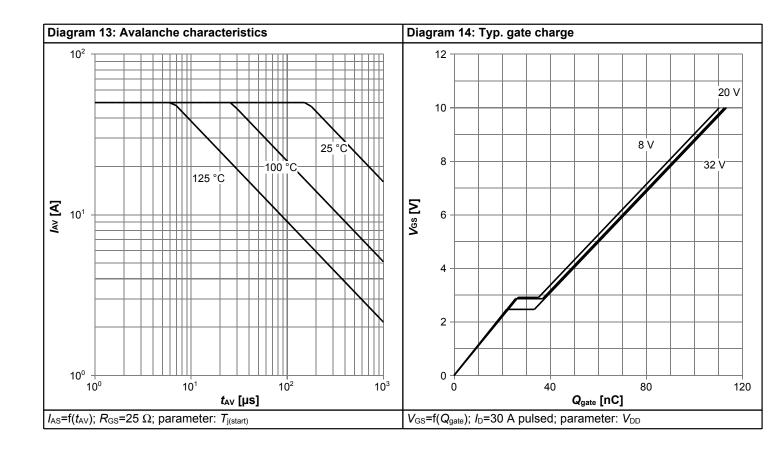


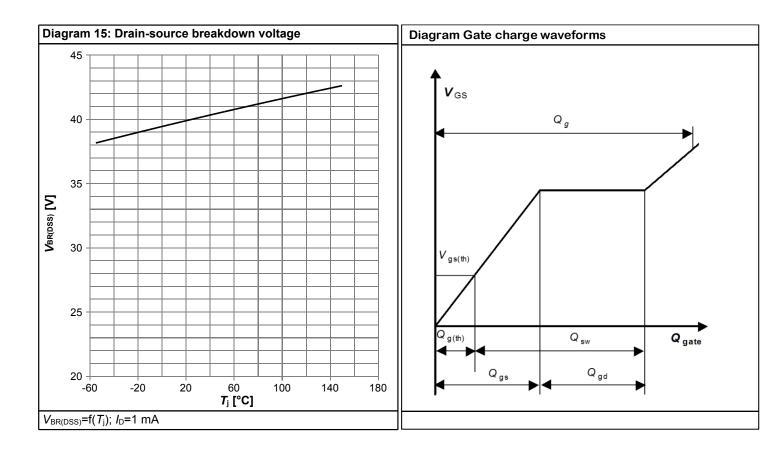






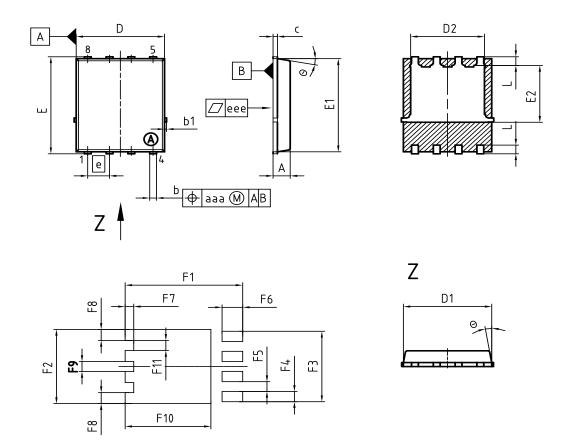








5 Package Outlines



DIM	MILLIM	IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	0.90	1.10	0.035	0.043			
b	0.34	0.54	0.013	0.021			
b1	0.02	0.22	0.001	0.008			
С	0.15	0.35	0.006	0.014			
D=D1	4.95	5.35	0.195	0.211			
D2	4.20	4.40	0.165	0.173			
E	5.95	6.35	0.234	0.250			
E1	5.70	6.10	0.224	0.240			
E2	3.40	3.80	0.134	0.150			
е	1.2	27	0.050				
N		8	8				
L	0.45	0.65	0.018	0.026			
Θ	8.5°	11.5°	8.5°	11.5°			
aaa	0.2	25	0.0	010			
eee	0.0)5	0.002				
F1	6.75	6.95	0.266	0.274			
F2	4.60	4.80	0.181	0.189			
F3	4.36	4.56	0.172	0.180			
F4	0.55	0.75	0.022	0.030			
F5	0.52	0.72	0.020	0.028			
F6	1.10	1.30	0.043	0.051			
F7	0.40	0.60	0.016	0.024			
F8	0.60	0.80	0.024	0.031			
F9	0.53	0.73	0.021	0.029			
F10	4.90	5.10	0.193	0.201			
F11	0.53	0.73	0.021	0.029			

	DOCUMENT NO. Z8B00003332					
SCALE	0 1					
0 2.5 ll.	2.5					
EUROPEAN P	ROJECTION					
ISSUE D 08-03-2						
REVIS 03	ION					

Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



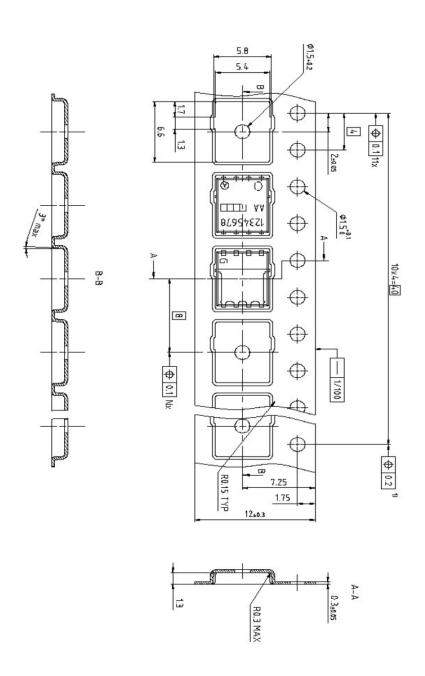


Figure 2 Outline Tape (PG-TDSON-8), dimensions in mm

OptiMOS[™]3 Power-Transistor, 40 V BSC018N04LS G



Revision History

BSC018N04LS G

Revision: 2020-08-14, Rev. 2.1

Previous Revision

1 10110401	Tovious Novicin						
Revision	Date	Subjects (major changes since last revision)					
1.4	2020-07-23	Release of preliminary datasheet					
2.1	2020-08-14	Update current rating and footnotes					

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2020 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.